

## Surface Mount Superfast Recovery Rectifier

Reverse Voltage – 50 to 600 V Forward Current –5 A

### FEATURES

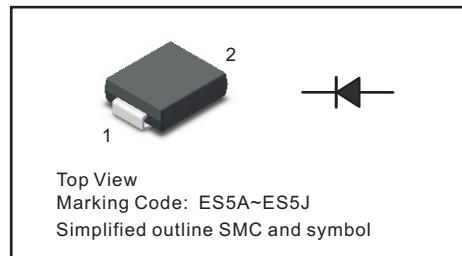
- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives

### MECHANICAL DATA

- Case : SMC
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight : 0.22g / 0.0077oz

### PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



### Absolute Maximum Ratings and Characteristics

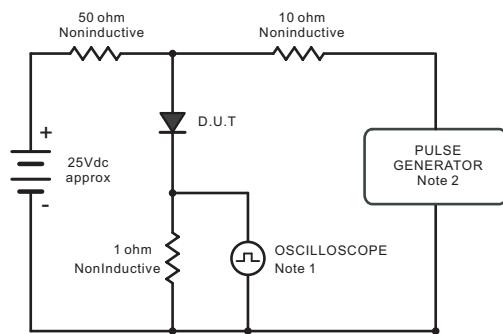
Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Symbols	ES5AC G	ES5BC G	ES5CC G	ES5DC G	ES5EC G	ES5GC G	ES5JC G	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	50	100	150	200	300	400	600	V
Maximum RMS voltage	V <sub>RMS</sub>	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current at T <sub>c</sub> = 100 °C	I <sub>F(AV)</sub>					5			A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I <sub>FSM</sub>					120			A
Maximum Forward Voltage at 5 A	V <sub>F</sub>			1			1.25	1.68	V
Maximum DC Reverse Current T <sub>a</sub> = 25 °C at Rated DC Blocking Voltage T <sub>a</sub> = 125 °C	I <sub>R</sub>			5		100			µA
Typical Junction Capacitance at V <sub>R</sub> =4V, f=1MHz	C <sub>j</sub>			50					pF
Maximum Reverse Recovery Time <sup>(1)</sup>	t <sub>rr</sub>			35					ns
Typical Thermal Resistance <sup>(2)</sup>	R <sub>θJA</sub> R <sub>θJC</sub>			35		13			°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>			-55 ~ +150					°C

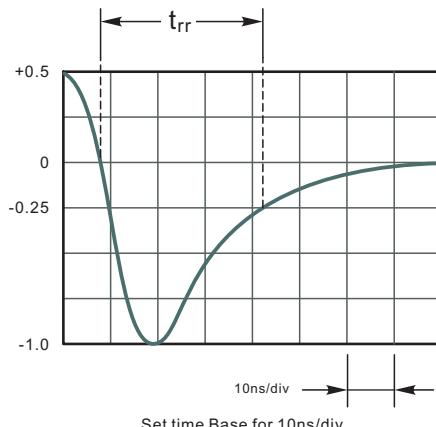
( 1 ) Measured with I<sub>F</sub> = 0.5 A, I<sub>R</sub> = 1 A, I<sub>rr</sub> = 0.25 A.

( 2 ) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

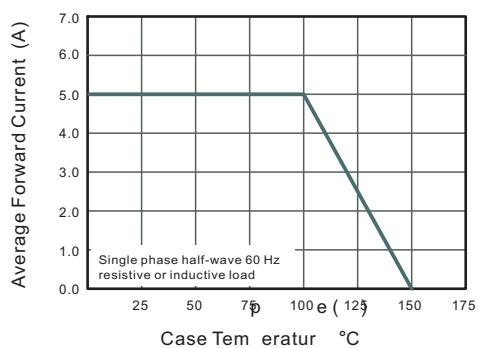
**Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram**



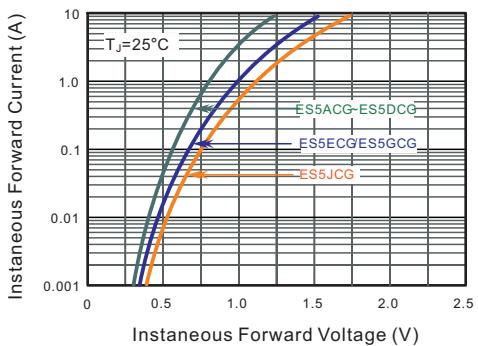
Note: 1. Rise Time = 7ns, max.  
 Input Impedance = 1megohm,22pF.  
 2. Ries Time =10ns, max.  
 Source Impedance = 50 ohms.



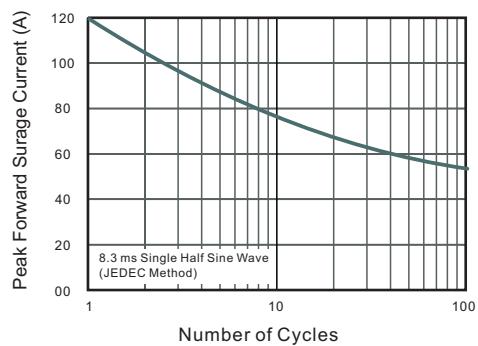
**Fig.2 Maximum Average Forward Current Rating**



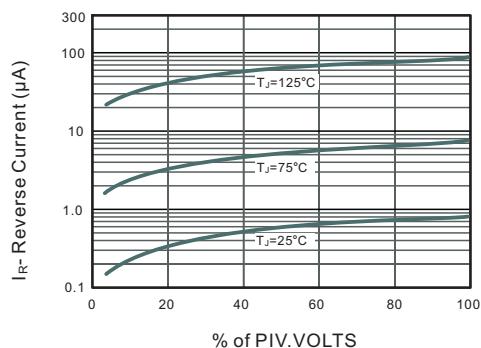
**Fig.4 Typical Forward Characteristics**



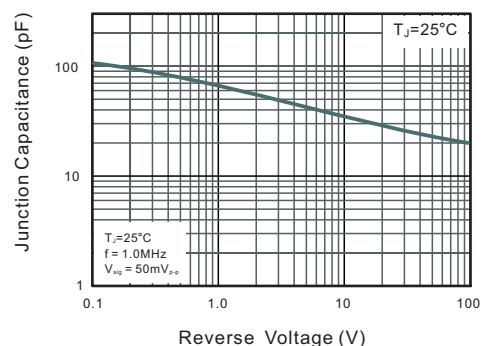
**Fig.6 Maximum Non-Repetitive Peak Forward Surge Current**



**Fig.3 Typical Reverse Characteristics**

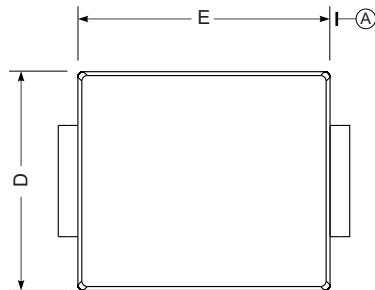
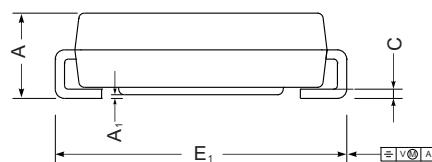
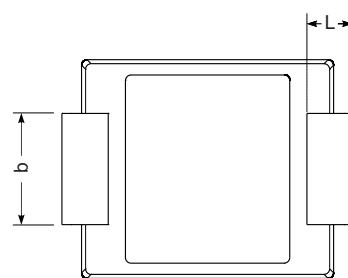


**Fig.5 Typical Junction Capacitance**

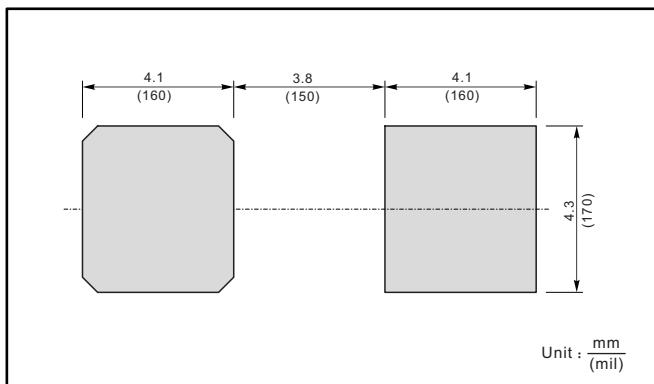


**PACKAGE OUTLINE**

Plastic surface mounted package; 2 leads


**SMC**

**SMC mechanical data**

UNIT		A	E	D	E <sub>1</sub>	A <sub>1</sub>	C	L	b
mm	max	2.62	7.0	6.2	8.0	0.21	0.31	1.6	3.25
	min	2.00	6.5	5.6	7.6	0.05	0.15	0.9	2.75
mil	max	103	276	244	315	8.3	12	63	128
	min	79	256	220	299	2.0	5.9	35	108

**The recommended mounting pad size**

**Marking**

Type number	Marking code
ES5ACG	ES5A
ES5BCG	ES5B
ES5CCG	ES5C
ES5DCG	ES5D
ES5ECG	ES5E
ES5GCG	ES5G
ES5JCG	ES5J